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Microwave-assisted selective heating to rapidly construct a nano-cracked hollow

sponge for stretch sensing

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Figure S1 Digital photos showing the uniform and stable GO and CNT/CS

suspensions.



Figure S2 Surface morphology of the coated backbone with one layer of GO/CNT (a)

and neat ME backbone (b).



Figure S3 Digital photo showing the integrated sensor (copper electrodes have been embedded in sensor).



Figure S4 The microstructure and morphology of MW-treated sponge upon 2 (a, b)

and 4 s (c, d) irradiation.



Figure S5 The electrical conductivity of MW-treated coated sponge with different coating layer of GO/CNT as a function of irradiation time.



Figure S6 SEM image showing the skeleton with microcrack caused by MW heating.



Figure S7 XPS results showing the element composition of GO/CNT@ME sponge

upon 0 (a), 6 (b) and 10 s (c) MW irradiation.



Figure S8 SEM images showing the hollow backbones in MW-treated sponge after

the degradation of ME matrix.



Figure S9 SEM images showing the structure of GO@ME (a, b) and CNT@ME (c, d)

sponge after 10 s MW irradiation.



Figure S10 Relative increase of GO, CNT, and GO/CNT coating mass on ME sponge with different number of bilayer.



Figure S11 Raman spectra of MW-treated GO/CNT@ME sponge after different

irradiation time and the related values of $I_{\text{D}}/I_{\text{G}}$



Figure S12 The formation and recovery of cracks in sensor during stretching-release process (bright regions representing the formed cracks among backbones).



Figure S13 A self-build equipment for evaluating the stretch sensing behavior of

MW-treated sponge sensors.

Sample	Conductivity before MW	Conductivity after MW	
	irradiation (S/m)	irradiation (S/m)	
GO@ME sponge	< 10 ⁻⁶	< 10 ⁻⁶	
CNT@ME sponge	5.3±0.2	4.0±0.5	
GO/CNT@ME sponge	0.57±0.06	38.1±3.0	

before and after MW irradiation (10 s)

Sensor	Minimum detected strain	Durability	
	(%)	(cycle)	Ref
rGO/CNT sponge	~1	>10000	This work
Carbonized silk fabric	~1	>10000	1
Fish-scale-like graphene	~0.1	>5000	2
MWCNTs/elastomer	-	>5000	3
SWNT/MWNT/TPU yarn	-	>2000	4
GnPs/silicon rubber	~2	>1000	5
Graphene/AgNPs/TPU	0.5	>1000	6
Binary rubber/graphene	~20	>300	7
TPU/CNTs/PDMS	<30	>700	8
CNT/TPU	0.5	>10 000	9

 Table S2 The comparison of sensitivity and durability of our sensor with other

 stretching sensors

Note: SWNT, single-walled carbon nanotube; TPU, thermoplastic polyurethane; GnPs, graphene platelets; PDMS, polydimethylsiloxane.

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